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\* Exhibiting at the 1997 MRS Spring Meeting

## MRS Invites Nominations for the Von Hippel Award, MRS Medal, and Turnbull Lectureship

The Materials Research Society is seeking nominations for the Von Hippel Award, the MRS Medal, and the Turnbull Lectureship. The deadline for nominations is **June 1, 1997**. These awards will be presented at the 1997 MRS Fall Meeting, December 1–5, in Boston.

The MRS Awards Program recognizes outstanding contributors to the progress of materials research. Nomination forms and details about eligibility and nomination criteria are available from Anne Wagner, Materials Research Society, 9800 McKnight Road, Pittsburgh, PA 15237-6006; phone 412-367-3004 ext. 102; fax 412-367-4373. Further information about each award can also be obtained from MRS homepage on the World Wide Web: <http://www.mrs.org>.

### Von Hippel Award Acknowledges Outstanding Interdisciplinary Work in Materials Research

The Von Hippel Award, first presented to Arthur R. von Hippel whose interdisciplinary and pioneering research typified the spirit of the award, is the Materials Research Society's highest honor. The recipient is recognized for brilliance and originality combined with vision that transcends the boundaries of conventional scientific disciplines. The Award includes a \$10,000 cash prize, honorary membership in MRS, and a unique trophy—a mounted ruby laser crystal symbolizing the many-faceted nature of materials research.

Selection of the recipient is determined by a vote of the MRS Council. The recipi-

ent will be invited to speak at the Awards Ceremony.


### Turnbull Lectureship Honors Career of an Outstanding Researcher and Communicator

The David Turnbull Lectureship recognizes the career of a scientist who has made outstanding contributions to understanding materials phenomena and properties through research, writing, and lecturing, as exemplified by the life work of David Turnbull. While honoring the accomplishments of the recipient, the Turnbull Lectureship is intended to support and enrich the materials research community.

The recipient will give a technical lecture of broad appeal at a designated session of the 1997 MRS Fall Meeting. The Turnbull Lecturer will receive a \$5,000 honorarium and a citation plaque, along with travel expenses paid to enable the recipient to address MRS Sections and University Chapters, and/or participate in the production of a video version of the lecture.

### MRS Medal Recognizes Recent Discovery or Advancement in Materials Science

The MRS Medal offers public and professional recognition of an exceptional recent achievement in materials research. A medal will be awarded for a specific outstanding recent discovery or advancement which is expected to have a major impact on the progress of any materials-related field.

The award consists of a \$3,000 cash prize, an engraved and mounted medal, and a citation certificate. 

## 1997 MRS Spring Meeting

### Outstanding Young Investigator Award: Christopher N. Bowman, University of Colorado

"Polymerization and Properties of Polymer Stabilized Ferroelectric Liquid Crystals"

Wednesday, April 2, 5:00 p.m.

Golden Gate AI, San Francisco Marriott



# Corporate Affiliates

(as of January 1997)

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